PRODUCT DATA SHEET



PhlatLight® White LED Illumination Products

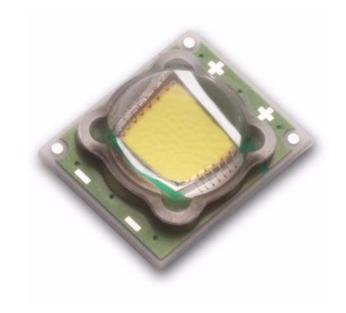
SST-50 Series

Features

- Extremely high optical output: Over 1,250 lumens from a single chip (white)
- Extremely high efficiency: Over 100 lumens per watt at 1.75A
- High thermal conductivity package junction to case thermal resistance of only 2.45 $^{\circ}\text{C/W}$
- Large, monolithic chip with uniform emitting area of 5 mm²
- Lumen maintenance of greater than 70% after 60,000 hours
- · Environmentally friendly: RoHS compliant
- Variable drive currents: less than 1 A through 5 A to full reliability specifications
- · High reliability
- · Electrically isolated thermal path

Applications

- Replacement Lamps
- High Bay Lighting
- · Street Lighting
- Consumer Portable
- · Architectural Lighting
- · Retail Lighting
- · Residential Lighting
- Spot Lighting



PhlatLight[®] LEDs enable a new class of illumination applications.

Table of Contents

Technology Overview	. 2
Test Specifications	. 2
PhlatLight Bin Codes	. 3
Product Shipping and Labeling Information	. 7
Optical and Electrical Characteristics	. 8
Spectral Characteristics	10
Radiation Patterns	11
Thermal Resistance	12
Mechanical Dimensions - Emitter	13
Mechanical Dimensions - Star	14
Solder Profile	15
Ordering Information	16





Technology Overview

PhlatLight LEDs benefit from a suite of innovations in the fields of chip technology, packaging, and thermal management. These breakthroughs allow illumination designers to achieve efficient light engine designs and deliver high brightness solutions.

PhlatLight Technology

The name PhlatLight is derived from Photonic Lattice. Photonic lattice technology creates true surface emission from the source, which enables large area LED chips with uniform brightness over the entire LED chip surface. The optical power and brightness produced by these large monolithic chips enable solutions which replace arc and halogen lamps where arrays of traditional high power LEDs cannot.

Packaging Technology

Thermal management is critical in high power LED applications. With a thermal resistance from junction to case of 2.45 °C/W, PhlatLight SST-50 devices have among the lowest thermal resistance values of any LED on the market. This allows the LED to be driven at higher current densities while maintaining a low junction temperature, thereby resulting in brighter and longer lifetimes. The package is easy to use, and ready to be mounted in the lighting system.

Reliability

Designed from the ground up, PhlatLight LEDs are one of the most reliable light sources in the world today. PhlatLight LEDs have passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity, and have been fully qualified for use in extreme high power and high current applications. With very low failure rates and median lifetimes that are well above 60,000 hours, PhlatLight LEDs are ready for the most demanding applications.

Environmental Benefits

PhlatLight LEDs help reduce power consumption and the amount of hazardous waste entering the environment. All PhlatLight products manufactured by Luminus are RoHS compliant and free of hazardous materials, including lead and mercury.

Understanding PhlatLight Test Specifications

Every PhlatLight LED device is fully tested to ensure that it meets the high quality standards of Luminus' products.

Multiple Operating Points (1.75A, 5.0A)

The tables on the following pages provide typical optical and electrical characteristics. Since the LEDs can be operated over a wide range of drive conditions (currents from less than 1.0A to 5.0A, and duty cycle from <1% to 100%) multiple drive conditions are listed.

PhlatLight SST-50 devices are production tested at 1.75A. The values shown at 5.0A are for additional reference at other possible drive conditions.





PhlatLight White Binning Structure

PhlatLight SST-50 White LEDs are tested for luminous flux and chromaticity at a drive current of 1.75A and placed into one of the following luminous flux (FF) and chromaticity (WW) bins:

For ordering information, please refer to page 16 or PDS-001393: PhlatLight Binning and Labeling.

Flux Bins ($T_J = 25$ °C)

Color	Flux Bin (FF)	Minimum Flux (Im) @ 1.75 A	Maximum Flux (Im) @ 1.75 A
W/FC	WG	275	350
W65S 6500K, Standard CRI (typ. 70)	WH	350	425
(3)	WJ	425	500
1415.70	WG	275	350
W57S 5700K, Standard CRI (typ. 70)	WH	350	425
5700K, Standard CKI (typ. 70)	WJ	425	500
WAEC	WG	275	350
W45S 4500K, Standard CRI, (typ. 70)	WH	350	425
isosity standard stay (typ: 10)	WJ	425	500
W30M	WF	220	275
3000K, Moderate CRI, (typ. 83)	WG	275	350

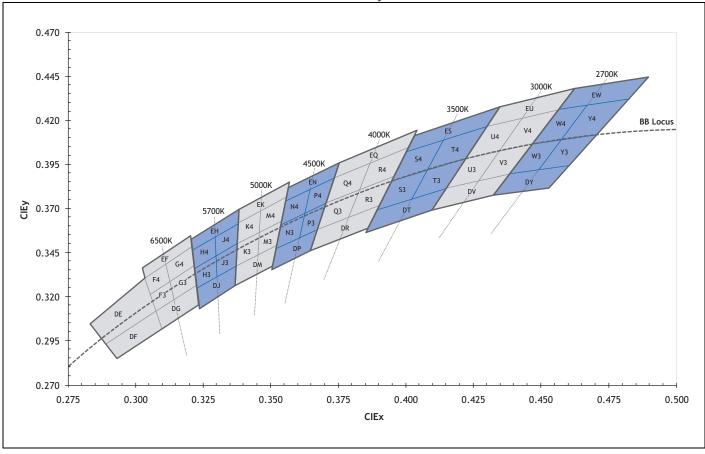
 $[\]bullet$ Note: Luminus maintains a tolerance of +/- 6% on flux measurements.





Chromaticity Bins

Luminus' Standard Chromaticity Bins: 1931 CIE Curve







The following tables describe the four chromaticity points that bound each chromaticity bin. Chromaticity bins are grouped together based on the color temperature.

6500K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.307	0.311	
DG	0.322	0.326	
DO	0.323	0.316	
	0.309	0.302	
	0.305	0.321	
F3*	0.313	0.329	
13	0.315	0.319	
	0.307	0.311	
	0.303	0.330	
F4*	0.312	0.339	
14	0.313	0.329	
	0.305	0.321	
	0.313	0.329	
G3*	0.321	0.337	
0.5	0.322	0.326	
	0.315	0.319	
	0.312	0.339	
G4*	0.321	0.348	
04	0.321	0.337	
	0.313	0.329	
	0.302	0.335	
EF	0.320	0.354	
Li	0.321	0.348	
	0.303	0.330	
	0.283	0.304	
DE	0.303	0.330	
DL	0.307	0.311	
	0.289	0.293	
	0.289	0.293	
DF	0.307	0.311	
Di	0.309	0.302	
	0.293	0.285	

5700K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.322	0.324	
DJ	0.337	0.337	
DJ	0.336	0.326	
	0.323	0.314	
	0.321	0.335	
H3*	0.329	0.342	
113	0.329	0.331	
	0.322	0.324	
	0.321	0.346	
H4*	0.329	0.354	
П4	0.329	0.342	
	0.321	0.335	
	0.329	0.342	
J3*	0.337	0.349	
JS	0.337	0.337	
	0.330	0.331	
	0.329	0.354	
.J4*	0.338	0.362	
J4	0.337	0.349	
	0.329	0.342	
	0.320	0.352	
FH	0.338	0.368	
LII	0.338	0.362	
	0.321	0.346	

5000K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.338	0.368	
FK	0.356	0.384	
LK	0.355	0.376	
	0.338	0.362	
	0.337	0.349	
K3*	0.345	0.355	
KJ	0.345	0.343	
	0.337	0.337	
	0.338	0.362	
K4*	0.347	0.369	
N4	0.345	0.355	
	0.337	0.349	
	0.345	0.355	
M3*	0.353	0.362	
IVIS	0.352	0.349	
	0.344	0.343	
	0.346	0.369	
M4*	0.355	0.376	
IVI	0.353	0.362	
	0.345	0.355	
	0.337	0.337	
DM	0.352	0.349	
DIVI	0.350	0.337	
	0.336	0.326	

 $^{^{\}star}$ Sub-bins within ANSI defined quadrangles per ANSI C78.377-2008





4500k Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.356	0.384	
EN	0.376	0.396	
LIV	0.374	0.387	
	0.355	0.374	
	0.353	0.360	
N3*	0.361	0.366	
INO	0.359	0.352	
	0.351	0.347	
	0.355	0.374	
N4*	0.364	0.381	
11/4	0.361	0.366	
	0.353	0.360	
	0.361	0.366	
P3*	0.370	0.373	
rs	0.367	0.358	
	0.359	0.352	
	0.364	0.381	
P4*	0.374	0.387	
F4	0.370	0.373	
	0.361	0.366	
	0.351	0.347	
DP	0.367	0.358	
υr	0.364	0.346	
	0.350	0.335	

4000K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.376	0.396	
EO	0.404	0.414	
LQ	0.401	0.404	
	0.374	0.387	
	0.370	0.373	
03*	0.382	0.380	
Q3	0.378	0.365	
	0.367	0.358	
	0.374	0.387	
Q4*	0.387	0.396	
	0.382	0.380	
	0.370	0.373	
	0.382	0.380	
R3*	0.395	0.388	
KS	0.390	0.372	
	0.378	0.365	
	0.387	0.396	
R4*	0.401	0.404	
Κ4	0.395	0.388	
	0.382	0.380	
	0.367	0.358	
DR	0.390	0.372	
טא	0.386	0.359	
	0.364	0.346	

3500K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.403	0.411	
ES	0.435	0.427	
L3	0.430	0.417	
	0.400	0.402	
	0.394	0.385	
S3*	0.407	0.392	
33	0.402	0.375	
	0.389	0.369	
	0.400	0.402	
S4*	0.415	0.409	
34	0.407	0.392	
	0.394	0.385	
	0.407	0.392	
T3*	0.422	0.399	
13	0.415	0.381	
	0.402	0.375	
	0.415	0.409	
T4*	0.430	0.417	
14	0.422	0.399	
	0.407	0.392	
	0.389	0.369	
DT	0.415	0.381	
	0.409	0.369	
	0.385	0.357	

3000K Chi	romaticity	y Bins
Bin Code (WW)	CIEx	CIEy
	0.435	0.427
EU	0.462	0.437
EU	0.456	0.426
	0.430	0.417
	0.422	0.399
U3*	0.434	0.403
03	0.426	0.385
	0.415	0.381
U4*	0.430	0.417
	0.443	0.421
	0.434	0.403
	0.422	0.399
	0.434	0.403
V3*	0.447	0.408
٧s	0.437	0.389
	0.426	0.385
	0.443	0.421
V4*	0.456	0.426
V 1	0.447	0.408
	0.434	0.403
	0.415	0.381
DV	0.437	0.389
υv	0.431	0.377
	0.409	0.369

2700K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.462	0.437	
EW	0.488	0.444	
LVV	0.481	0.432	
	0.456	0.426	
	0.447	0.408	
W3*	0.458	0.410	
VVS	0.448	0.392	
	0.437	0.389	
	0.456	0.426	
W4*	0.469	0.429	
VV 4	0.458	0.410	
	0.447	0.408	
	0.458	0.410	
Y3*	0.470	0.413	
13	0.459	0.394	
	0.448	0.392	
	0.469	0.429	
Y4*	0.481	0.432	
14	0.470	0.413	
	0.458	0.410	
	0.437	0.389	
DY	0.459	0.394	
D1	0.452	0.382	
	0.431	0.377	

^{*} Sub-bins within ANSI defined quadrangles per ANSI C78.377-2008





PhlatLight Product Shipping and Labeling Information

All PhlatLight products are packaged and labeled with their respective bin as outlined in the tables on page 3. When shipped, each package will only contain one bin. The part number designation is as follows:

SST — 50 — WNNX — F21 — FF — WW

Product Family	Chip Area	Color	Package Configuration	Flux Bin	Chromaticity Bin
SST: Surface Mount	50: 5.0 mm ²	WNNX: CCT and CRI See Note 1 Below	F21: 7mm x 9mm emitter	See page 3 for bins	See page 4 for bins

Note 1. WNNX nomenclature corresponds to the following:

W = White

NN = color temperature, where:

65 corresponds to 6500K

40 corresponds to 4000K

30 corresponds to 3000K, etc.

X = color rendering index, where:

S (standard) corresponds to a typical CRI of 70

M (moderate) corresponds to a typical CRI of 83

H (high) corresponds to a typical CRI of 92.

Note 2. Some flux and chromaticity bins may have limited availability. Application specific bin kits, consisting of multiple bins, may be available. For ordering information, please refer to page 16 and reference the PhlatLight Binning and Labeling document.

Example: The part label SST-50-W65S-F21-WJ-G4 refers to a 6500K standard CRI white, SST-50 emitter, F21 package configuration, with a flux range of 425 to 500 lumens and a chromaticity value within the box defined by the four points (0.313, 0.338), (0.321, 0.348), (0.322, 0.336), (0.312, 0.328).

Example: The part label SST-50-W30M-F21-WF-U3 refers to a 3000K moderate CRI white, SST-50 emitter, F21 package configuration, with a flux range of 220 to 275 lumens and a chromaticity value within the box defined by the four points (0.422, 0.399), (0.434, 0.403), (0.426, 0.386), (0.415, 0.381).





Optical and Electrical Characteristics (T_J = 25 °C)

White					
Drive Condition ¹		1.75A	5.0 A		
Parameter	Symbol	Typical Values at Test Current	Values at Indicated Currents ²	Unit	
Current Density	j	0.35	1.0	A/mm ²	
	$V_{F,min}$	2.5		V	
Forward Voltage	$V_{F,typ}$	3.2	3.6	V	
	V _{F,max}	3.9		V	

Common Characteristics

	Symbol	Values	Unit
Viewing Angle	2θ _{1/2}	100	degrees
Emitting Area		5.0	mm ²
Emitting Area Dimensions		2.25 x 2.25	mmxmm
Forward Voltage Temperature Coefficient ³		-4.4	mV/°C

Absolute Maximum Ratings

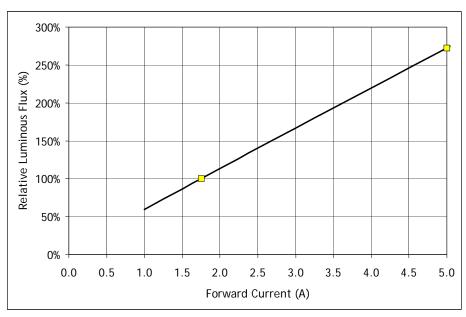
	Symbol	Values	Unit
Maximum Current ⁴		5.0	А
Maximum Reverse Current		Not Allowed	А
Maximum Junction Temperature ⁵	T _{j-max}	150	°C
Storage Temperature Range		-40/+100	°C

- Note 1: Listed drive conditions are typical for common applications. PhlatLight SST-50-W devices can be driven at currents ranging from <1A to 5A and at duty cycles ranging from <1% to 100%. Drive current and duty cycle should be adjusted as necessary to maintain the junction temperature desired to meet application lifetime requirements.
- Note 2: Unless otherwise noted, values listed are typical.
- Note 3: Forward voltage temperature coefficient at 1.75A. Contact Luminus for value at other drive conditions.
- Note 4: Luminus PhlatLight SST-50-W LEDs are designed for operation to an absolute maximum forward drive current 5A. Product lifetime data is specified at recommended forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to recommended forward drive currents. Actual device lifetimes will also depend on junction temperature. Refer to APN-001521: Reliability Application Note for SST-50-W for further information. In pulsed operation, rise time from 10-90% of forward current should be larger than 0.5 microseconds.
- Note 5: Lifetime dependent on LED junction temperature. Thermal calculations based on input power and thermal management system should be performed to ensure Tj is maintained below Tjmax rating or life will be reduced. Refer to APN-001521 for further information.
- Note 6: CIE measurement uncertainty for white devices is estimated to be +/- 0.01.
- Note 7: Special design considerations must be observed for operation under 1A. Please contact Luminus for further information.
- Note 8: Caution must be taken not to stare at the light emitted from these LEDs. Under special circumstances, the high intensity could damage the eye.

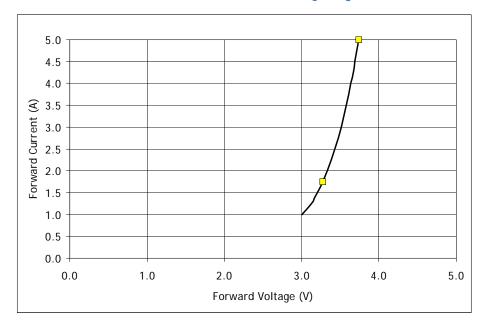








Forward Current vs. Forward Voltage $(T_J = 25^{\circ}C)^1$

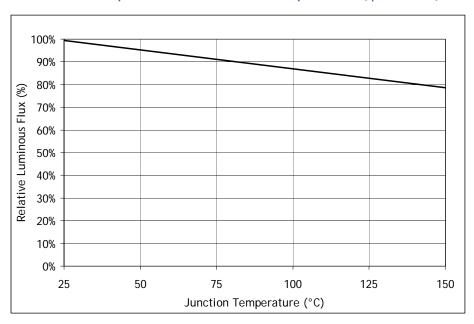


^{1.} Yellow squares indicate typical operating conditions.

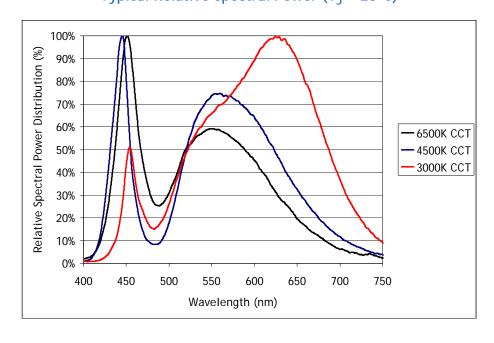




Relative Output Flux vs. Junction Temperature ($I_F = 1.75A$)



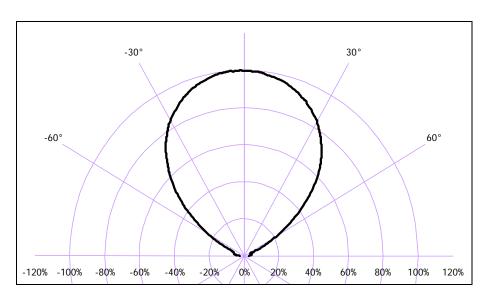
Typical Relative Spectral Power ($T_J = 25$ °C)



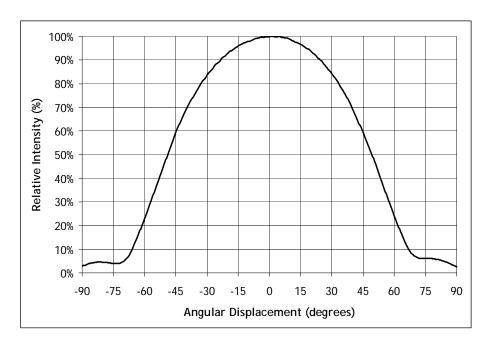








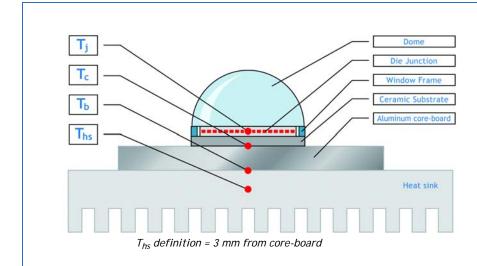
Typical Angular Radiation Pattern







Thermal Resistance



Typical Thermal Resistance

R _{j-c} ¹	2.45 °C/W
R_{j-b}^{1}	4.28 °C/W
R_{j-hs}^2	4.39 °C/W

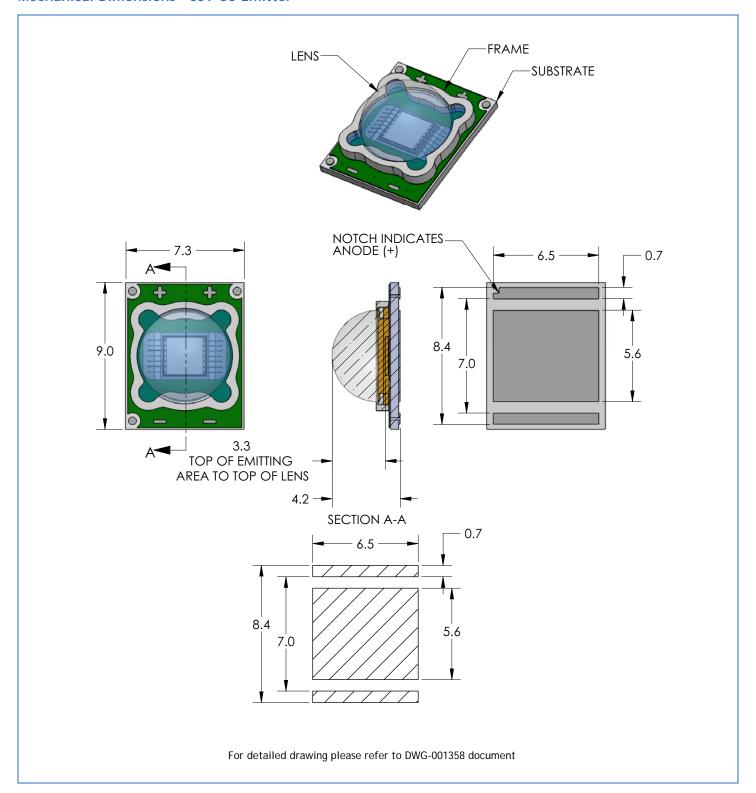
Note 1: Thermal resistance values are based on FEA model results correlated to measured $R_{\theta j\text{-}hs}$

Note 2: Thermal resistance is measured using a SAC305 solder, a
Bergquist Al-clad MCPCB, and eGraf 1205 thermal interface material.





Mechanical Dimensions - SST-50 Emitter

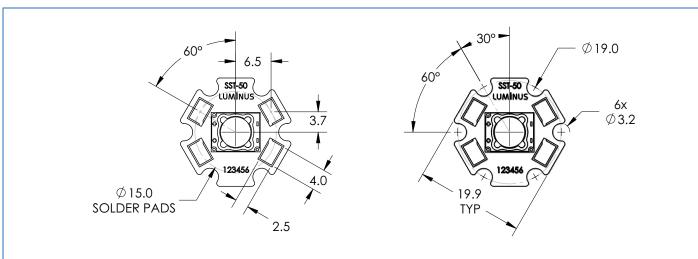


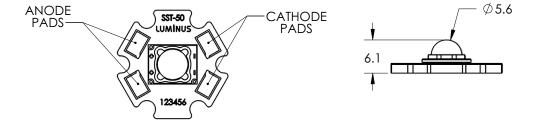




Mechanical Dimensions - SST-50 Star

PhlatLight SST-50-W devices are available on a star board for prototyping purposes. Please see page 16 for ordering information.







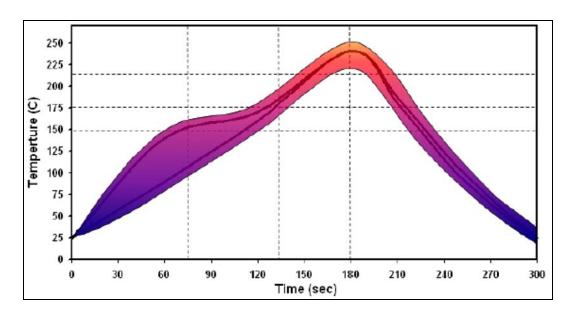
Notes:

- 1. Recommended mounting screw: M3 or #4
- 2. All dimensions in millimeters
- 3. All anode pads on board are interconnected. All cathode pads on board are interconnected





Reflow Soldering Characteristics



Solder profile guideline

Solder Profile Stage	Lead-free solder	Lead-based solder
Profile Length, Ambient to Peak	2.75 - 3.5 minutes	2.75 - 3.5 minutes
Time Maintained Above: Temperature	217 °C	183 °C
Time Maintained Above: Time	30 - 60 seconds	30-60 seconds
Cooldown Rate	≤ 4° C/sec	≤ 4° C/sec
Cooldown Duration	45 ± 15 sec	45 ± 15 sec

- Note: 1. Temperatures are taken and monitored at the component copper layer
- Note: 2. Optimum profile may differ due to oven type, circuit board or assembly layout
- Note: 3. Recommended lead free, no-clean solder: AIM NC254-SAC305
- Note: 4. Refer to APN-001473: PhlatLight Soldering and Handling application note for additional solder profiles and details.





Ordering Information

Ordering Part Number ^{1,2}	Color	Description
SST-50-WDLS-F21-GG150	6500K White 5700K White	White PhlatLight SST-50 surface mount device consisting of a domed 5mm ² LED mounted on a ceramic substrate.
SST-50-WCLS-F21-GG350	5000K White 4500K White	White PhlatLight SST-50 surface mount device consisting of a domed 5mm ² LED mounted on a ceramic substrate.
SST-50-WWTM-F21-GF550	4000K White 3500K White	White PhlatLight SST-50 surface mount device consisting of a domed 5mm ² LED mounted on a ceramic substrate.
SST-50-WWRM-F21-GF750	3000K White 2700K White	White PhlatLight SST-50 surface mount device consisting of a domed 5mm ² LED mounted on a ceramic substrate.

SSR-50-WDLS-R21-GG150	6500K White 5700K White	PhlatLight SSR-50 evaluation module consisting of a SST-50 surface mount device mounted on an aluminum star board.
SSR-50-WCLS-R21-GG350	5000K White 4500K White	PhlatLight SSR-50 evaluation module consisting of a SST-50 surface mount device mounted on an aluminum star board.
SSR-50-WWTM-R21-GF550	4000K White 3500K White	PhlatLight SSR-50 evaluation module consisting of a SST-50 surface mount device mounted on an aluminum star board.
SSR-50-WWRM-R21-GF750	3000K White 2700K White	PhlatLight SSR-50 evaluation module consisting of a SST-50 surface mount device mounted on an aluminum star board.

Note 1: GG150 - denotes a bin kit comprising of all flux and chromaticity bins at the 6500K and 5700K color points GG350 - denotes a bin kit comprising of all flux and chromaticity bins at the 5000K and 4500K color points GF550 - denotes a bin kit comprising of all flux and chromaticity bins at the 4000K and 3500K color points

GF750 - denotes a bin kit comprising of all flux and chromaticity bins at the 3000K and 2700K color points

Note 2: For ordering information on all available bin kits, please see PDS-001393: PhlatLight Binning and Labeling document







www.luminus.com

The products, their specifications and other information appearing in this document are subject to change by Luminus Devices without notice. Luminus Devices assumes no liability for errors that may appear in this document, and no liability otherwise arising from the application or use of the product or information contained herein. None of the information provided herein should be considered to be a representation of the fitness or suitability of the product for any particular application or as any other form of warranty. Luminus Devices' product warranties are limited to only such warranties as accompany a purchase contract or purchase order for such products. Nothing herein is to be construed as constituting an additional warranty. No information contained in this publication may be considered as a waiver by Luminus Devices of any intellectual property rights that Luminus Devices may have in such information. PhlatLight[®] is a registered trademark of Luminus Devices, Inc., all rights reserved.

a.This product is protected by U.S. Patents 6,831,302; 7,074,631; 7,083,993; 7,084,434; 7,098,589; 7,105,861; 7,138,666; 7,166,870; 7,166,871; 7,170,100; 7,196,354; 7,211,831; 7,262,550; 7,274,043; 7,301,271; 7,341,880; 7,344,903; 7,345,416; 7,348,603; 7,388,233; 7,391,059; Patents Pending in the U.S. and other countries.

